

GENERAL DESCRIPTION

OB3392K is an offline LED lighting controller with primary side control, high power factor and high constant current (CC) precision, which can achieve low system cost for an isolated lighting application in a single stage converter. It significantly simplifies the LED lighting system design by eliminating the secondary side feedback components and the opto-coupler.

The proprietary CC control scheme is used and the system can achieve high power factor with constant on-time control scheme. Quasi-resonant (QR) operation and clamping frequency greatly improves the system efficiency. The constant output current is compensated for tolerance of transformer inductance variation. And the line compensation and load compensation are built in OB3392K for high precisely constant output current control.

OB3392K offers comprehensive protection coverage with auto-recovery features including LED open loop protection, LED short circuit protection, cycle-by-cycle current limiting, built-in leading edge blanking, VDD under voltage lockout (UVLO), etc.

OB3392K is offered in SOT23-6 package.

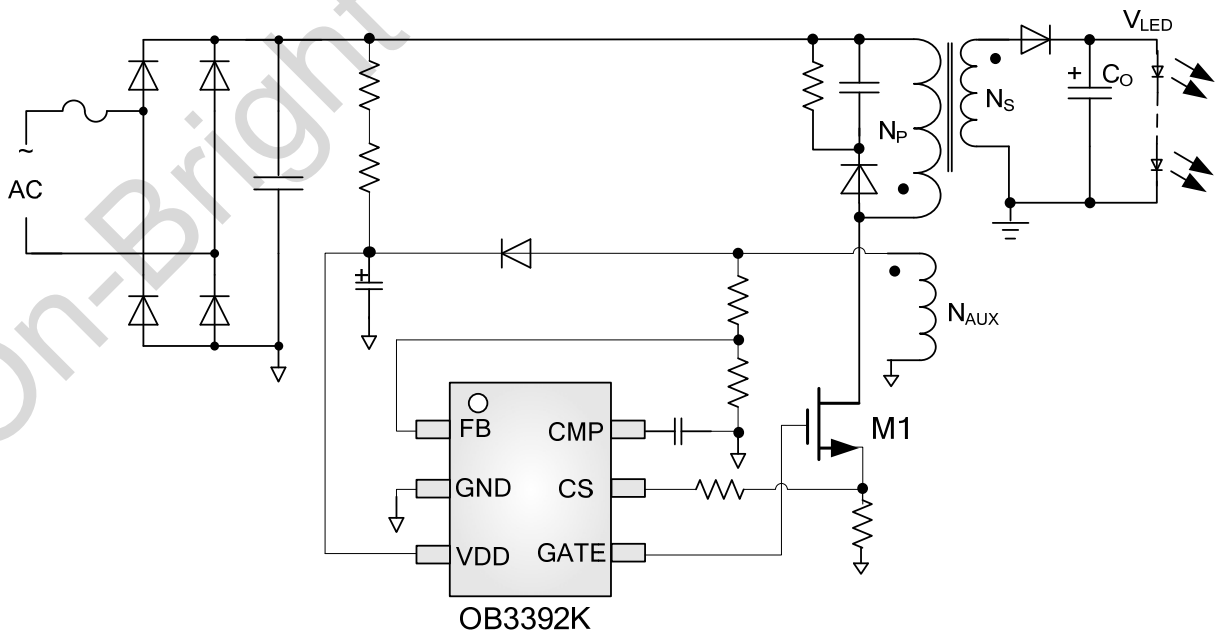
FEATURES

- High power factor
- High precision constant current regulation at universal AC input
- Primary-side sensing and regulation without TL431 and opto-coupler
- Low system cost and high efficiency
- Quasi-resonant operation
- Programmable CC regulation
- Built-in primary winding inductance compensation
- Built-in line compensation
- Built-in load compensation
- LED short circuit protection
- LED open loop protection
- Cycle-by-cycle current limiting
- Built-in leading edge blanking (LEB)
- VDD under voltage lockout with hysteresis
- VDD over voltage protection
- Over temperature protection (OTP)

APPLICATIONS

- LED lighting

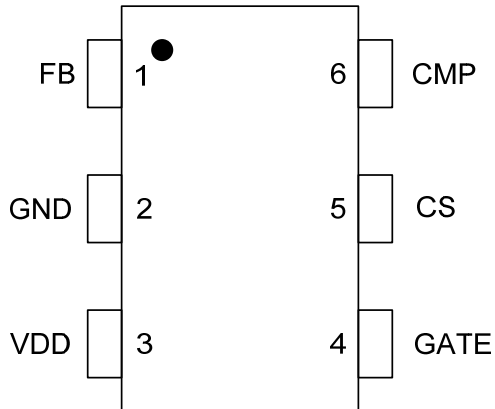
TYPICAL APPLICATION



GENERAL INFORMATION

Pin Configuration

The pin map is shown as below for SOT23-6.



Ordering Information

Part Number	Description
OB3392KMP	SOT23-6, Pb-free, T&R

Note: All Devices are offered in Pb-free Package if not otherwise noted.

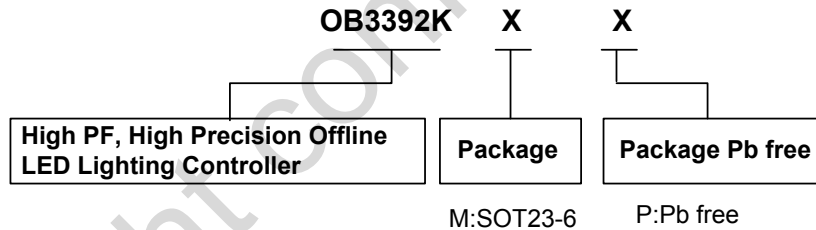
Package Dissipation Rating

Package	R θ JA (°C/W)
SOT23-6	200

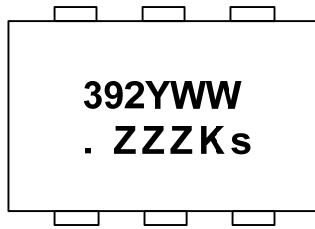
Absolute Maximum Ratings

Parameter	Value
VDD Voltage	-0.3 to 40V
Gate Voltage	-0.3 to 13V
CS Input Voltage	-0.3 to 7V
FB Input Voltage	-0.3 to 7V
COMP Voltage	-0.3 to 7V
Min/Max Operating Junction Temperature T _J	-40 to 150 °C
Min/Max Storage Temperature T _{stg}	-55 to 150 °C
Lead Temperature (Soldering, 10secs)	260 °C

Note: Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute maximum-rated conditions for extended periods may affect device reliability.



Marking Information

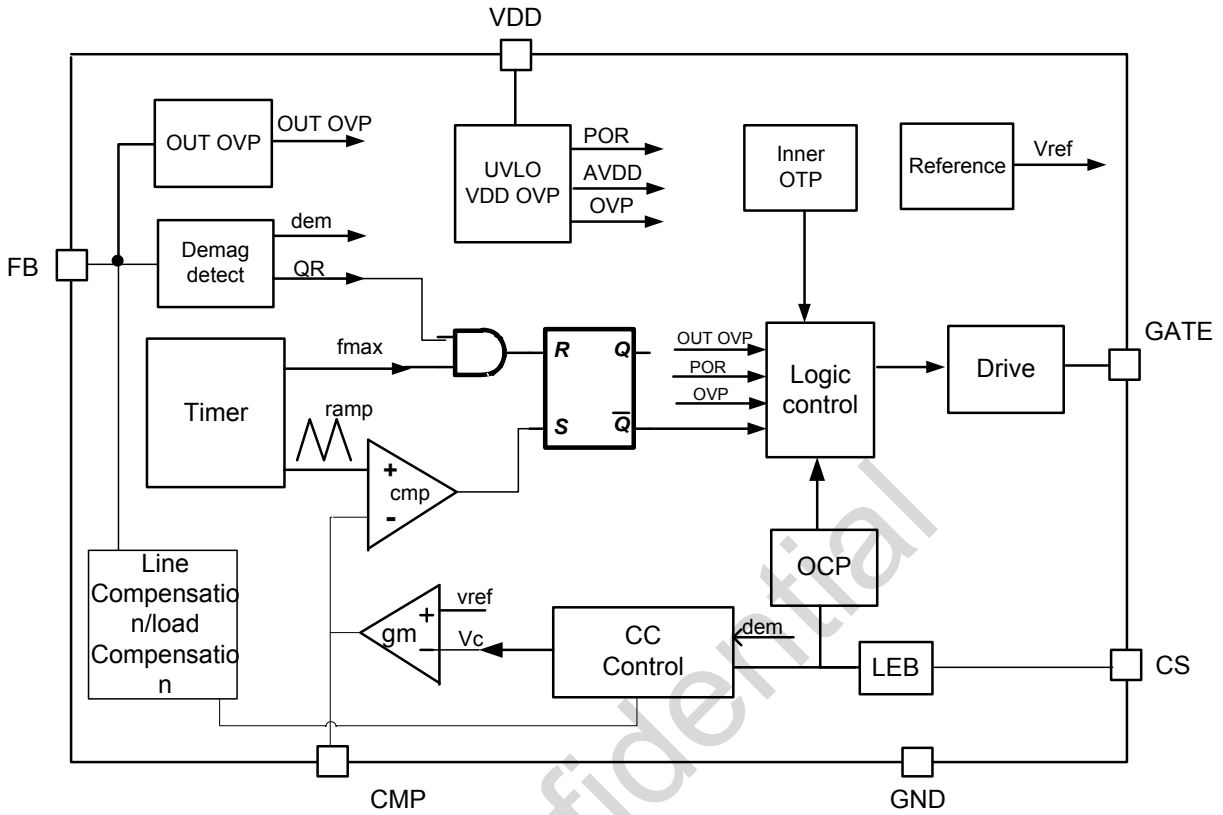


Y:Year Code
 WW:Week Code(01-52)
 ZZZ: Lot code
 K:Character Code
 s: Internal code

TERMINAL ASSIGNMENTS

Pin Num	Pin Name	I/O	Description
1	FB	I	Voltage feedback from auxiliary winding. Connected to resistor divider from auxiliary winding reflecting output voltage.
2	GND	P	Power Ground.
3	VDD	P	Power supply Input.
4	GATE	O	Gate driver output for power MOSFET.
5	CS	I	Current sensing terminal.
6	CMP	O	Loop compensation pin. A capacitor is connected between CMP and GND.

BLOCK DIAGRAM

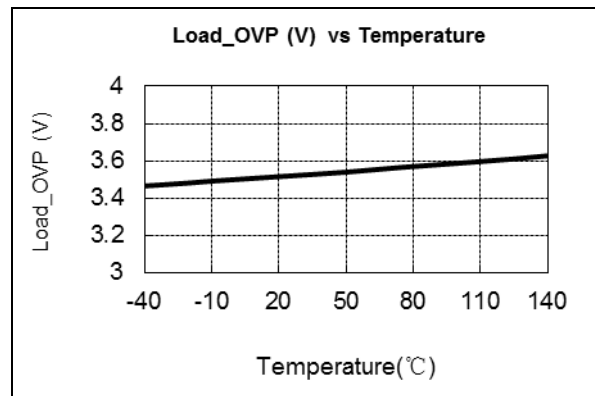
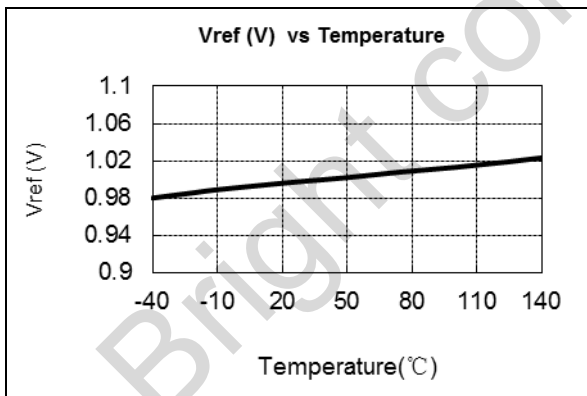
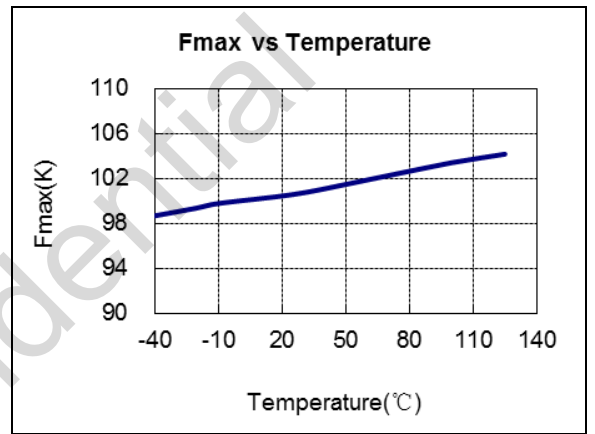
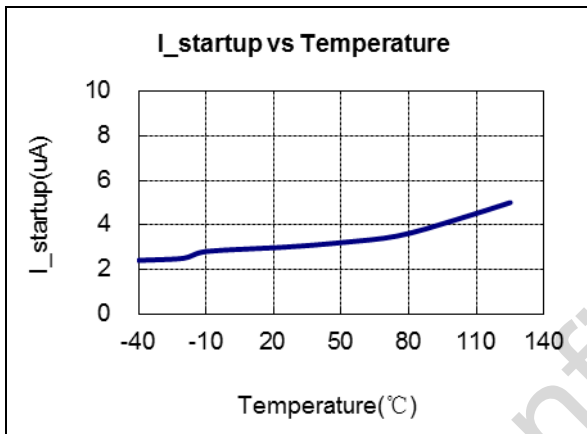
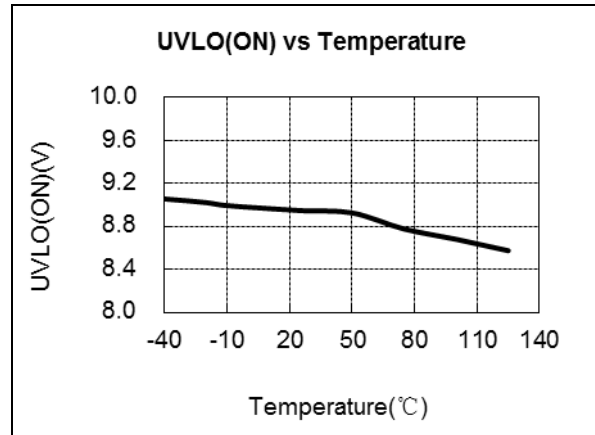
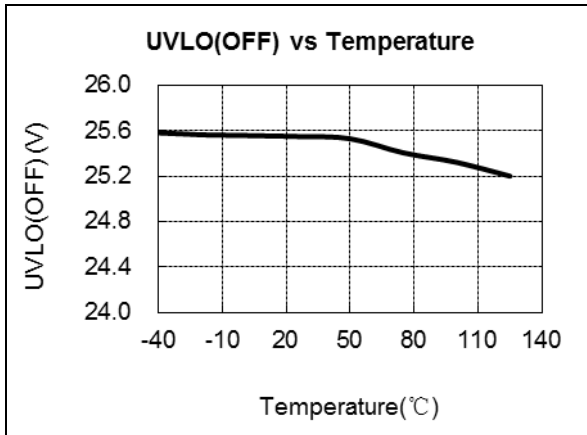


ELECTRICAL CHARACTERISTICS

(TA = 25°C, VDD=20V, if not otherwise noted)

Symbol	Parameter	Test Conditions	Min	Typ.	Max	Unit
Supply Voltage (VDD) Section						
I _{start-up}	Start up current	VDD=UVLO(OFF)-1V		3	7	uA
I _{op}	Operation current	VDD=20V, no loading		1.5	2.2	mA
UVLO(OFF)	VDD under voltage lockout exit		24	25.5	27	V
UVLO(ON)	VDD under voltage lockout enter		8	9	10	V
VDD_OVP	VDD Over Voltage Protection		32	35	38	V
Current Sense Input Section						
TLEB	LEB time			0.3		us
Vth_ocp	Over Current Threshold	FB>0.45V	0.95	1.00	1.05	V
		FB<0.45V		0.5		V
FB Input Section						
Vout_ovp	Output Over Voltage Protection		3.4	3.5	3.6	V
Vout_scp	Output Short Circuit Protection			0.45		V
QR Section						
Fmax	Maximum Working Frequency			100		KHz
Toff_max	Maximum Off Time	CMP=4.2V		70		us
Toff_min	Minimum Off Time	CS>0.15V		2		us
		CS<=0.15V		0.5		us
Ton_max	Maximum On Time	CMP=4.2V		25		us
Error Amplifier Section						
Vref	Error Amplifier Reference Voltage		0.196	0.200	0.204	V
Gm	Error Amplifier Transconductance			50		us
Isource_max	Error Amplifier Maximum Source Current			10		uA
Isink_max	Error Amplifier Maximum Sink Current			50		uA
Vclamp_cmp	CMP Pin Down_clamp Voltage			1.2		V
Gate Driver Section						
Vol	Output Low Level	Iout=10mA			1	V
Voh	Output High Level	Iout=10mA	6			V
Vclamp	Output Up-Clamping Voltage			12		V
Tr	Rising Edge Time	Cl=1nF		110		ns
Tf	Falling Edge Time	Cl=1nF		70		ns

CHARACTERIZATION PLOTS



OPERATION DESCRIPTION

OB3392K is a primary-side-control and high power factor fly-back PWM controller specialized for LED lighting application. It operates in primary side sensing and regulation, thus opto-coupler and TL431 are not required. OB3392K works at Quasi-Resonant operation with maximum working frequency clamping, which can improve the efficiency of LED lighting system design.

- **Start up Control**

Low start-up current is designed in OB3392K so that VDD could be charged up above UVLO threshold with small charging current. A large value startup resistor can therefore be used to minimize the power loss in application.

The capacitor at CMP pin is pulled up quickly during starting up until its voltage reaches 1.2V. Then the error amplifier charges the CMP pin capacitor with a transconductance of about 500uS (typical), and the Gate drives external power MOSFET at minimum frequency for low power dissipation. At the startup, the threshold voltage of OCP is set at 0.5V (typical). When the voltage at FB pin reaches 0.45V (typical), the threshold voltage of OCP is increased to 1V (typical). When the voltage at FB pin increases and reaches 1.2V (typical), the transconductance of error amplifier is reduced to 50uS (typical).

- **LED Constant Current Regulation**

The LED output current equals to the average of the output rectifier diode current. So the LED output current is related with the transformer peak current value and the transformer current discharge time. The transformer current discharge time is sensed through FB pin and the transformer peak current value is determined by internal reference voltage. A proprietary CC control block calculates LED output current through the CS pin peak current value and the transformer current discharge time. The output of the calculation is compared with an internal precise reference to generate an error voltage (Vcmp), which determines the turn-on time in voltage mode control. The LED output current can be approximated as:

$$I_{LED} = \eta \cdot \frac{N}{2} \cdot \frac{V_{ref}}{R_{CS}}$$

η — The transformer coupling coefficient.

N — Turn ratio of primary side winding to secondary side winding.

Rcs — The sensing resistor connected between the MOSFET source and GND.

Vref — Internal reference voltage.

- **PFC and THD**

The duration of the turn on period t_{on} is generated by comparing an internal fixed saw-tooth wave with the voltage on the CMP pin. During steady state operation, the voltage on the CMP pin V_{cmp} is slowly varying due to a large external capacitor connected at the CMP pin, therefore the turn on time t_{on} is constant. In a fly-back topology, constant turn on time and quasi-resonant operation provide high power factor (PF) and low total harmonic distortion (THD).

- **Current Sensing and Leading Edge Blanking**

Cycle-by-Cycle current limiting (OCP) is offered in OB3392K. The switching current is detected by a sense resistor connected between the CS pin and GND. An internal leading edge blanking circuit chops off the sense voltage spike at initial MOSFET on state due to snubber diode reverse recovery so that the external RC filter is no longer required. The current limit comparator is disabled at this blanking time and thus the external MOSFET cannot be turned off during this blanking time.

- **Quasi-Resonant Operation**

OB3392K performs quasi-resonant detection through FB pin by monitoring the voltage activity on the auxiliary windings in series with external resistors. When the stored energy of fly-back transformer is fully released to the output, the voltage at FB pin decreases. When FB pin voltage falls below 0.1V (typical), an internal FB comparator is triggered and a new PWM switching cycle is initiated following the FB triggering.

- **Line/Load Compensation**

OB3392K provides internal line compensation and load compensation to avoid using outside sensing devices. The compensated voltage is added to CS voltage cycle-by-cycle and LED output current is kept constant under different line voltage and output voltage.

- **Output OVP Protection**

An output over-voltage condition is monitored independently by the voltage at pins FB. During normal operation, when the voltage at FB pin exceeds a threshold of approximately 3.5V (typical), the over-voltage protection function is activated and the GATE is turned off immediately until VDD voltage drops below UVLO (ON), and the device enters power on startup sequence thereafter.

- **VDD Over Voltage Protection**

VDD is supplied with transformer auxiliary winding output. When VDD is higher than 35V (typical), VDD OVP protection is triggered and GATE is shut

down, and the device enters power on startup sequence thereafter.

- **LED Short Circuit Protection**

When LED string is short, the positive plateau of auxiliary winding voltage is also near zero and the FB voltage is low. If the voltage at FB pin is lower than a threshold of approximately 0.45V (typical), the IC will work at minimum frequency and the threshold voltage of OCP is reduced to 0.5V (typical). The power dissipation is greatly reduced in this way.

- **LED Open Circuit Protection**

When the LED string open circuit happens, the positive plateau of auxiliary winding voltage increases and the FB pin voltage is high. If the voltage at FB pin is higher than a threshold of approximately 3.5V (typical), the IC will shut down and enter power on startup sequence thereafter.

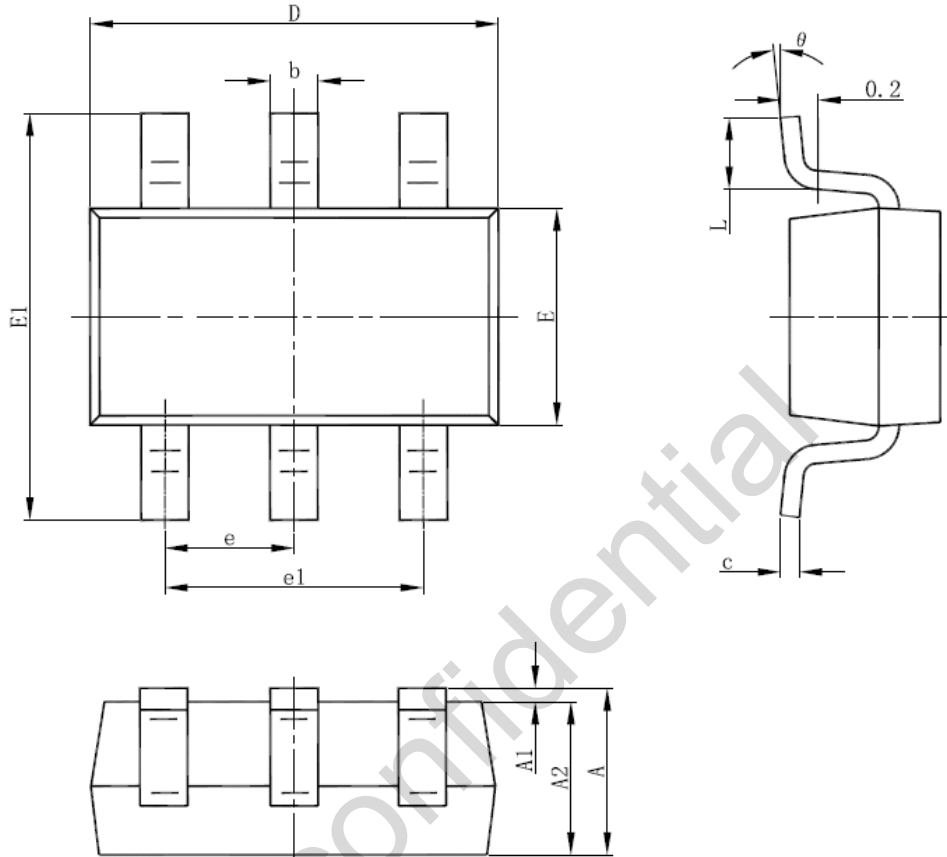
- **Gate Driver**

The GATE pin is connected to the gate of an external power switch. An internal 12V (typical) clamp is added for MOSFET gate protection at high VDD voltage. When VDD voltage drops below UVLO(ON), the GATE pin is internally pulled low to maintain the off state.

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PACKAGE MECHANICAL DATA

SOT-23-6L PACKAGE OUTLINE DIMENSIONS



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.000	1.450	0.039	0.057
A1	0.000	0.150	0.000	0.006
A2	0.900	1.300	0.035	0.051
b	0.300	0.500	0.012	0.020
c	0.080	0.220	0.003	0.009
D	2.800	3.020	0.110	0.119
E	1.500	1.726	0.059	0.068
E1	2.600	3.000	0.102	0.118
e	0.950 (BSC)		0.037 (BSC)	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
theta	0°	8°	0°	8°

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